

Electronic Patent Application Fee Transmittal

Application Number:	10562235				
Filing Date:					
Title of Invention:	Manufacturing method of semiconductor wafer and semiconductor wafer manufactured by this method				
First Named Inventor/Applicant Name:	Syouji Nogami				
Filer:	Jules Edward Goldberg				
Attorney Docket Number:	JG-SU-5224/500577.20073				
Filed as Large Entity					
U.S. National Stage under 35 USC 371 Filing Fees					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:					
Pages:					
Claims:					
Miscellaneous-Filing:					
Late filing fee for oath or declaration	1051	1	130	130	
Petition:					
Patent-Appeals-and-Interference:					
Post-Allowance-and-Post-Issuance:					
Extension-of-Time:					

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				130